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Dated: October 23, 2007

Signature: \_\_\_\_\_

(Renee DesRosiers)

Docket No.: 60803 (49381)  
(PATENT)

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of:  
Kazuya Fujita et al.

Application No.: 10/773,809

Confirmation No.: 8452

Filed: February 5, 2004

Art Unit: 2814

For: SOLID STATE IMAGING DEVICE,  
SEMICONDUCTOR WAFER, OPTICAL  
DEVICE MODULE, METHOD OF SOLID  
STATE IMAGING DEVICE FABRICATION,  
AND METHOD OF OPTICAL DEVICE  
MODULE FABRICATION

Examiner: W. S. Louie

**RESPONSE TO FINAL OFFICE ACTION**

MS RCE  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

**INTRODUCTORY COMMENTS**

In response to the Final Office Action dated July 23, 2007, please enter the following response, as this response is being filed along with a Request for Continued Examination (RCE):

**The Claims** are reflected in the listing of claims, which begins on page 2 of this paper.

**Remarks** begin on page 9 of this paper.